



# Platform Flash In-System Programmable Configuration PROMS

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Product Specification

## Features

- In-System Programmable PROMs for Configuration of Xilinx FPGAs
- Low-Power Advanced CMOS NOR FLASH Process
- Endurance of 20,000 Program/Erase Cycles
- Operation over Full Industrial Temperature Range (–40°C to +85°C)
- IEEE Standard 1149.1/1532 Boundary-Scan (JTAG) Support for Programming, Prototyping, and Testing
- JTAG Command Initiation of Standard FPGA Configuration
- Cascadable for Storing Longer or Multiple Bitstreams
- Dedicated Boundary-Scan (JTAG) I/O Power Supply ( $V_{CCJ}$ )
- I/O Pins Compatible with Voltage Levels Ranging From 1.5V to 3.3V
- Design Support Using the Xilinx Alliance ISE and Foundation ISE Series Software Packages
- XCF01S/XCF02S/XCF04S
  - ◆ 3.3V supply voltage
  - ◆ Serial FPGA configuration interface (up to 33 MHz)
  - ◆ Available in small-footprint VO20 and VOG20 packages.
- XCF08P/XCF16P/XCF32P
  - ◆ 1.8V supply voltage
  - ◆ Serial or parallel FPGA configuration interface (up to 33 MHz)
  - ◆ Available in small-footprint VO48, VOG48, FS48, and FSG48 packages
  - ◆ Design revision technology enables storing and accessing multiple design revisions for configuration
  - ◆ Built-in data decompressor compatible with Xilinx advanced compression technology

Table 1: Platform Flash PROM Features

Device	Density	$V_{CCINT}$	$V_{CCO}$ Range	$V_{CCJ}$ Range	Packages	Program In-system via JTAG	Serial Config.	Parallel Config.	Design Revisioning	Compression
XCF01S	1 Mbit	3.3V	1.8V – 3.3V	2.5V – 3.3V	VO20/VOG20	✓	✓			
XCF02S	2 Mbit	3.3V	1.8V – 3.3V	2.5V – 3.3V	VO20/VOG20	✓	✓			
XCF04S	4 Mbit	3.3V	1.8V – 3.3V	2.5V – 3.3V	VO20/VOG20	✓	✓			
XCF08P	8 Mbit	1.8V	1.5V – 3.3V	2.5V – 3.3V	VO48/VOG48 FS48/FSG48	✓	✓	✓	✓	✓
XCF16P	16 Mbit	1.8V	1.5V – 3.3V	2.5V – 3.3V	VO48/VOG48 FS48/FSG48	✓	✓	✓	✓	✓
XCF32P	32 Mbit	1.8V	1.5V – 3.3V	2.5V – 3.3V	VO48/VOG48 FS48/FSG48	✓	✓	✓	✓	✓

## Description

Xilinx introduces the Platform Flash series of in-system programmable configuration PROMs. Available in 1 to 32 Megabit (Mbit) densities, these PROMs provide an easy-to-use, cost-effective, and reprogrammable method for storing large Xilinx FPGA configuration bitstreams. The Platform Flash PROM series includes both the 3.3V XCFxxS PROM and the 1.8V XCFxxP PROM. The XCFxxS version includes 4-Mbit, 2-Mbit, and 1-Mbit PROMs that

support Master Serial and Slave Serial FPGA configuration modes (Figure 1, page 2). The XCFxxP version includes 32-Mbit, 16-Mbit, and 8-Mbit PROMs that support Master Serial, Slave Serial, Master SelectMAP, and Slave SelectMAP FPGA configuration modes (Figure 2, page 2). A summary of the Platform Flash PROM family members and supported features is shown in Table 1.

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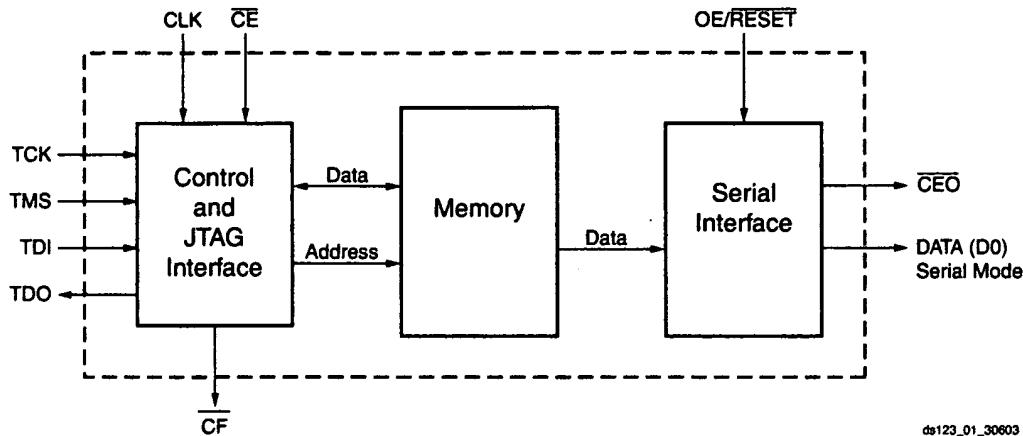


Figure 1: XCFxxS Platform Flash PROM Block Diagram

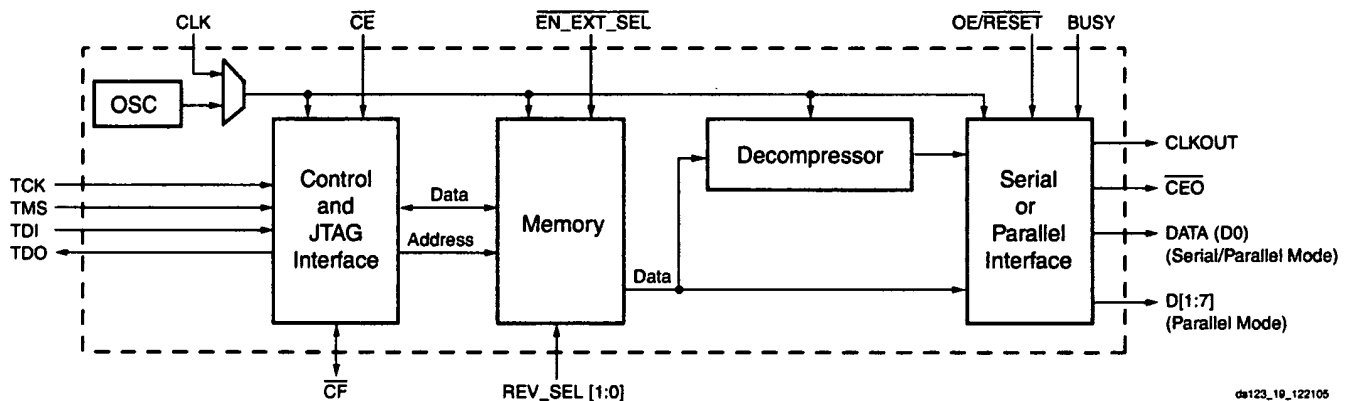


Figure 2: XCFxxP Platform Flash PROM Block Diagram

When the FPGA is in Master Serial mode, it generates a configuration clock that drives the PROM. With  $\overline{CF}$  High, a short access time after  $\overline{CE}$  and OE are enabled, data is available on the PROM DATA (D0) pin that is connected to the FPGA DIN pin. New data is available a short access time after each rising clock edge. The FPGA generates the appropriate number of clock pulses to complete the configuration.

When the FPGA is in Slave Serial mode, the PROM and the FPGA are both clocked by an external clock source, or optionally, for the XCFxxP PROM only, the PROM can be used to drive the FPGA's configuration clock.

The XCFxxP version of the Platform Flash PROM also supports Master SelectMAP and Slave SelectMAP (or Slave Parallel) FPGA configuration modes. When the FPGA is in Master SelectMAP mode, the FPGA generates a configuration clock that drives the PROM. When the FPGA is in Slave SelectMAP Mode, either an external oscillator generates the configuration clock that drives the PROM and the FPGA, or optionally, the XCFxxP PROM can be used to drive the FPGA's configuration clock. With BUSY Low and  $\overline{CF}$  High, after  $\overline{CE}$  and OE are enabled, data is available on

the PROMs DATA (D0-D7) pins. New data is available a short access time after each rising clock edge. The data is clocked into the FPGA on the following rising edge of the CCLK. A free-running oscillator can be used in the Slave Parallel /Slave SelectMAP mode.

The XCFxxP version of the Platform Flash PROM provides additional advanced features. A built-in data decompressor supports utilizing compressed PROM files, and design revisioning allows multiple design revisions to be stored on a single PROM or stored across several PROMs. For design revisioning, external pins or internal control bits are used to select the active design revision.

Multiple Platform Flash PROM devices can be cascaded to support the larger configuration files required when targeting larger FPGA devices or targeting multiple FPGAs daisy chained together. When utilizing the advanced features for the XCFxxP Platform Flash PROM, such as design revisioning, programming files which span cascaded PROM devices can only be created for cascaded chains containing only XCFxxP PROMs. If the advanced XCFxxP features are not enabled, then the cascaded chain can include both XCFxxP and XCFxxS PROMs.

The Platform Flash PROMs are compatible with all of the existing FPGA device families. A reference list of Xilinx FPGAs and the respective compatible Platform Flash PROMs is given in Table 2. A list of Platform Flash PROMs and their capacities is given in Table 3, page 4.

**Table 2: Xilinx FPGAs and Compatible Platform Flash PROMs**

FPGA	Configuration Bitstream	Platform Flash PROM <sup>(1)</sup>
<b>Virtex-5 LX</b>		
XC5VLX30	8,374,016	XCF08P
XC5VLX50	12,556,672	XCF16P
XC5VLX85	21,845,632	XCF32P
XC5VLX110	29,124,608	XCF32P
XC5VLX220	53,139,456	XCF32P+XCF32P
XC5VLX330	79,704,832	XCF32P+XCF32P+XCF16P
<b>Virtex-4 LX</b>		
XC4VLX15	4,765,568	XCF08P
XC4VLX25	7,819,904	XCF08P
XC4VLX40	12,259,712	XCF16P
XC4VLX60	17,717,632	XCF32P
XC4VLX80	23,291,008	XCF32P
XC4VLX100	30,711,680	XCF32P
XC4VLX160	40,347,008	XCF32P+XCF08P
XC4VLX200	51,367,808	XCF32P+XCF32P
<b>Virtex-4 FX</b>		
XC4VFX12	4,765,568	XCF08P
XC4VFX20	7,242,624	XCF08P
XC4VFX40	14,936,192	XCF16P
XC4VFX60	21,002,880	XCF32P
XC4VFX100	33,065,408	XCF32P
XC4VFX140	47,856,896	XCF32P+XCF16P
<b>Virtex-4 SX</b>		
XC4VSX25	9,147,648	XCF16P
XC4VSX35	13,700,288	XCF16P
XC4VSX55	22,749,184	XCF32P
<b>Virtex-II Pro X</b>		
XC2VPX20	8,214,560	XCF08P
XC2VPX70	26,098,976	XCF32P
<b>Virtex-II Pro</b>		
XC2VP2	1,305,376	XCF02S
XC2VP4	3,006,496	XCF04S
XC2VP7	4,485,408	XCF08P
XC2VP20	8,214,560	XCF08P
XC2VP30	11,589,920	XCF16P
XC2VP40	15,868,192	XCF16P
XC2VP50	19,021,344	XCF32P
XC2VP70	26,098,976	XCF32P
XC2VP100	34,292,768	XCF32P <sup>(2)</sup>

**Table 2: Xilinx FPGAs and Compatible Platform Flash PROMs (Continued)**

FPGA	Configuration Bitstream	Platform Flash PROM <sup>(1)</sup>
<b>Virtex-II<sup>(3)</sup></b>		
XC2V40	360,096	XCF01S
XC2V80	635,296	XCF01S
XC2V250	1,697,184	XCF02S
XC2V500	2,761,888	XCF04S
XC2V1000	4,082,592	XCF04S
XC2V1500	5,659,296	XCF08P
XC2V2000	7,492,000	XCF08P
XC2V3000	10,494,368	XCF16P
XC2V4000	15,659,936	XCF16P
XC2V6000	21,849,504	XCF32P
XC2V8000	29,063,072	XCF32P
<b>Virtex-E</b>		
XCV50E	630,048	XCF01S
XCV100E	863,840	XCF01S
XCV200E	1,442,016	XCF02S
XCV300E	1,875,648	XCF02S
XCV400E	2,693,440	XCF04S
XCV405E	3,430,400	XCF04S
XCV600E	3,961,632	XCF04S
XCV812E	6,519,648	XCF08P
XCV1000E	6,587,520	XCF08P
XCV1600E	8,308,992	XCF08P
XCV2000E	10,159,648	XCF16P
XCV2600E	12,922,336	XCF16P
XCV3200E	16,283,712	XCF16P
<b>Virtex</b>		
XCV50	559,200	XCF01S
XCV100	781,216	XCF01S
XCV150	1,040,096	XCF01S
XCV200	1,335,840	XCF02S
XCV300	1,751,808	XCF02S
XCV400	2,546,048	XCF04S
XCV600	3,607,968	XCF04S
XCV800	4,715,616	XCF08P
XCV1000	6,127,744	XCF08P
<b>Spartan-3E</b>		
XC3S100E	581,344	XCF01S
XC3S250E	1,352,192	XCF02S
XC3S500E	2,267,136	XCF04S

Table 2: Xilinx FPGAs and Compatible Platform Flash PROMs (Continued)

FPGA	Configuration Bitstream	Platform Flash PROM <sup>(1)</sup>
XC3S1200E	3,832,320	XCF04S
XC3S1600E	5,957,760	XCF08P
<b>Spartan-3L</b>		
XC3S1000L	3,223,488	XCF04S
XC3S1500L	5,214,784	XCF08P
XC3S5000L	13,271,936	XCF16P
<b>Spartan-3</b>		
XC3S50	439,264	XCF01S
XC3S200	1,047,616	XCF01S
XC3S400	1,699,136	XCF02S
XC3S1000	3,223,488	XCF04S
XC3S1500	5,214,784	XCF08P
XC3S2000	7,673,024	XCF08P
XC3S4000	11,316,864	XCF16P
XC3S5000	13,271,936	XCF16P
<b>Spartan-II</b>		
XC2S50E	630,048	XCF01S
XC2S100E	863,840	XCF01S
XC2S150E	1,134,496	XCF02S
XC2S200E	1,442,016	XCF02S
XC2S300E	1,875,648	XCF02S
XC2S400E	2,693,440	XCF04S
XC2S600E	3,961,632	XCF04S
<b>Spartan-II</b>		
XC2S15	197,696	XCF01S
XC2S30	336,768	XCF01S
XC2S50	559,200	XCF01S
XC2S100	781,216	XCF01S
XC2S150	1,040,096	XCF01S
XC2S200	1,335,840	XCF02S

**Notes:**

1. If design revisioning or other advanced feature support is required, the XCFxxP can be used as an alternative to the XCF01S, XCF02S, or XCF04S.
2. Assumes compression used.
3. The largest possible Virtex-II bitstream sizes are specified. Refer to the Virtex-II User Guide for information on bitgen options which affect bitstream size.

Table 3: Platform Flash PROM Capacity

Platform Flash PROM	Configuration Bits	Platform Flash PROM	Configuration Bits
XCF01S	1,048,576	XCF08P	8,388,608
XCF02S	2,097,152	XCF16P	16,777,216
XCF04S	4,194,304	XCF32P	33,554,432

## Programming

### In-System Programming

In-System Programmable PROMs can be programmed individually, or two or more can be daisy-chained together and programmed in-system via the standard 4-pin JTAG protocol as shown in Figure 3. In-system programming offers quick and efficient design iterations and eliminates unnecessary package handling or socketing of devices. The programming data sequence is delivered to the device using either Xilinx iMPACT software and a Xilinx download cable, a third-party JTAG development system, a JTAG-compatible board tester, or a simple microprocessor interface that emulates the JTAG instruction sequence. The iMPACT software also outputs serial vector format (SVF) files for use with any tools that accept SVF format, including automatic test equipment. During in-system programming, the  $\overline{CEO}$  output is driven High. All other outputs are held in a high-impedance state or held at clamp levels during in-system programming. In-system programming is fully supported across the recommended operating voltage and temperature ranges.

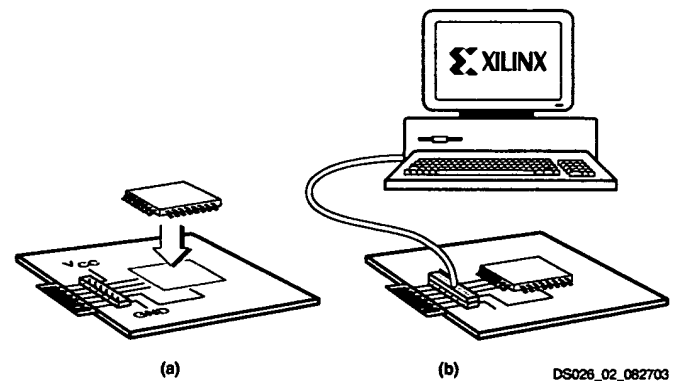


Figure 3: JTAG In-System Programming Operation

- (a) Solder Device to PCB  
(b) Program Using Download Cable

### OE/RESET

The 1/2/4 Mbit XCFxxS Platform Flash PROMs in-system programming algorithm results in issuance of an internal device reset that causes OE/RESET to pulse Low.

### External Programming

Xilinx reprogrammable PROMs can also be programmed by the Xilinx MultiPRO Desktop Tool or a third-party device programmer. This provides the added flexibility of using pre-programmed devices with an in-system programmable option for future enhancements and design changes.